

## MESSRS.

# SPECIFICATION FOR APPROVAL 承 认 书

Product	MAGNETIC BUZZER(SMD)
Part No.	HTV85058
Customer Approval	

Approved By	Checked By	Made By	
王台平	曹丽萍	LILY	
JAN-10-2019	JAN-10-2019	JAN-10-2019	

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EDITION:1.1



#### 1. Specifications

#### HTV85058(RoHS)

	Items	Units	Specifications	Conditions		
01	Rated Voltage	Vo-p	5.0	Vo-p		
02	Operating Voltage	Vo-p	3.6~6	0V		
03	Consumption Current	mA (max)	150	Standard State, Standard Drive Circuit.		
04	Sound Output	dB (min)	100	Rated Voltage,Rated Frequency ,Distance at 10cm free air,Square Wave 1 / 2 Duty		
05	Rated Frequency	Hz	4600			
06	Coil Resistance	Ω	13± 3	At Basic State		
07	Operating Temp.	$^{\circ}$ C	-20 ~ +60			
08	Storage Temp.	$^{\circ}$	-30 ~ +80			
09	Weight	Gram	0.8			
11	Housing Material		LCP( Black )			
12	Leading Pin		Tin Plated Brass(Sn )	See appearance drawing		

# 2.Test Condition STANDARD

Temperature : 15 ~ 35  $^{\circ}$ C

Relative humidity: 25% ~ 85%,

Atmospheric pressure: 860mbar to 1060mbar.

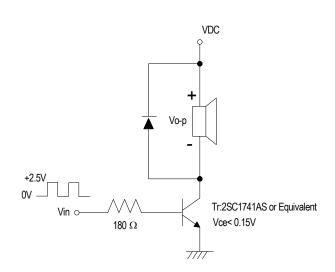
**JUDGEMENT** 

Temperature :  $20\pm3\,^{\circ}\mathrm{C}$ 

Relative humidity: 60% ~ 70%,

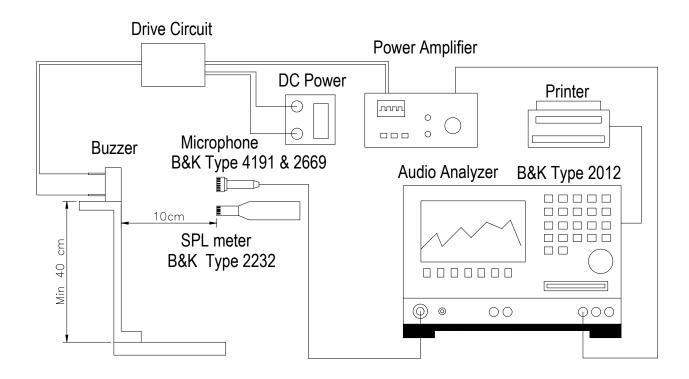
Atmospheric pressure: 860mbar to 1060mbar

#### **Standard Drive Circuit**

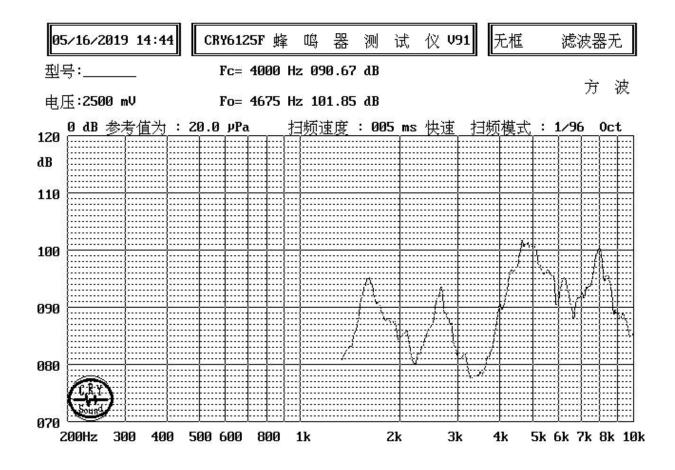




#### **Standard Test Fixture**

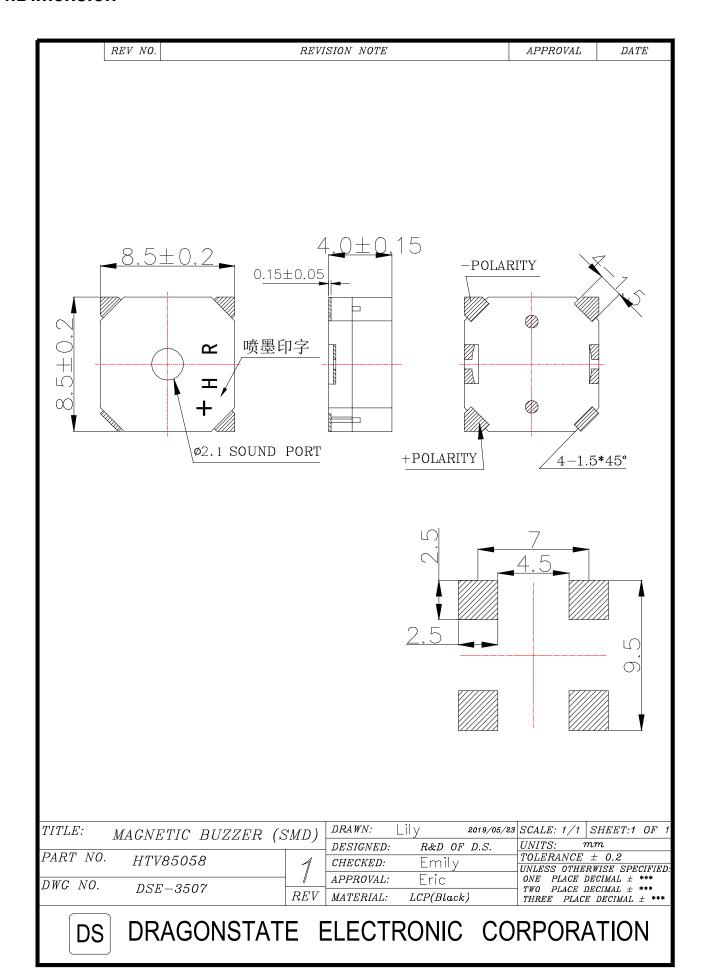


#### **Frequency Response Curve**





#### 4.Dimension





#### **5. RELIABILITY TEST**

NO.	ITEM	TEST CONDITION AND REQUIREMENT		
1	High Temperature Test (Storage)	After being placed in a chamber with 80±2°C for 96 hours and then being placed in normal condition for 2 hours.  Allowable variation of SPL after test: ±10dB.		
2	Low Temperature Test (Storage)	After being Placed in a chamber with -30±2°C for 96 hours and then being placed in normal condition for 2 hours.  Allowable variation of SPL after test: ±10dB.		
3	Humidity Test	After being Placed in a chamber with 90-95% R.H. at 40±2°C for 96 hours and then being placed in normal condition for 2 hours.  Allowable variation of SPL after test: ±10dB.		
4	Temperature Cycle Test	The part shall be subjected to 5 cycles. One cycle shall be consist of:  +60°C  +25°C  +25°C  +25°C  Allowable variation of SPL after test: ±10dB.		
5	Drop Test	Drop on a hard wood board of 4cm thick, any directions ,6 times, at the height of 75cm .Allowable variation of SPL after test: ±10dB.		
6	Vibration Test	After being applied vibration of amplitude of 1.5mm with 10 to 55 Hz band of vibration frequency to each of 3 perpendicular directions for 2 hours .Allowable variation of SPL after test: ±10dB.		
7	Solderability Test	Lead terminals are immersed in rosin for 5 seconds and then immersed in solder bath of +300±5°C for 3±1 seconds .  90% min. lead terminals shall be wet with solder (Except the edge of terminals).		
8	Terminal Strength Pulling Test	The force of 9.8N(1.0kg) is applied to each terminal in axial direction for 10 seconds.No visible damage and cutting off.		

#### **TEST CONDITION.**

Standard Test Condition : a) Temperature :  $+5 \sim +35 \,^{\circ}\text{C}$  b) Humidity : 45-85% c) Pressure : 860-1060mbar

一般测试条件 : a) 温度:+5~+35℃ b) 湿度:45-85% c) 气压:860-1060mbar

Judgment Test Condition : a) Temperature :  $+25 \pm 2^{\circ}$ C b) Humidity : 60-70% c) Pressure : 860-1060mbar

争议时测试条件 : a) 温度:+25±2℃ b) 湿度:60-70% c) 气压:860-1060mbar



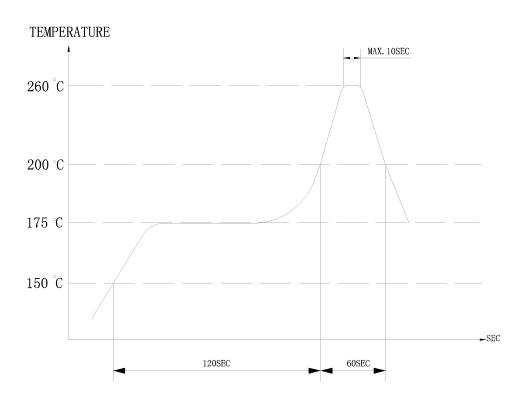
#### **SOLDER ABILITY**

(1)Recommendable reflow soldering condition is as following

( Allowed reflow process twice)

Maximum allowed temperature for reflow process is 265 °C/10 sec.

Note: It is requested that reflow soldering should be executed after heat of product goes down to normal.

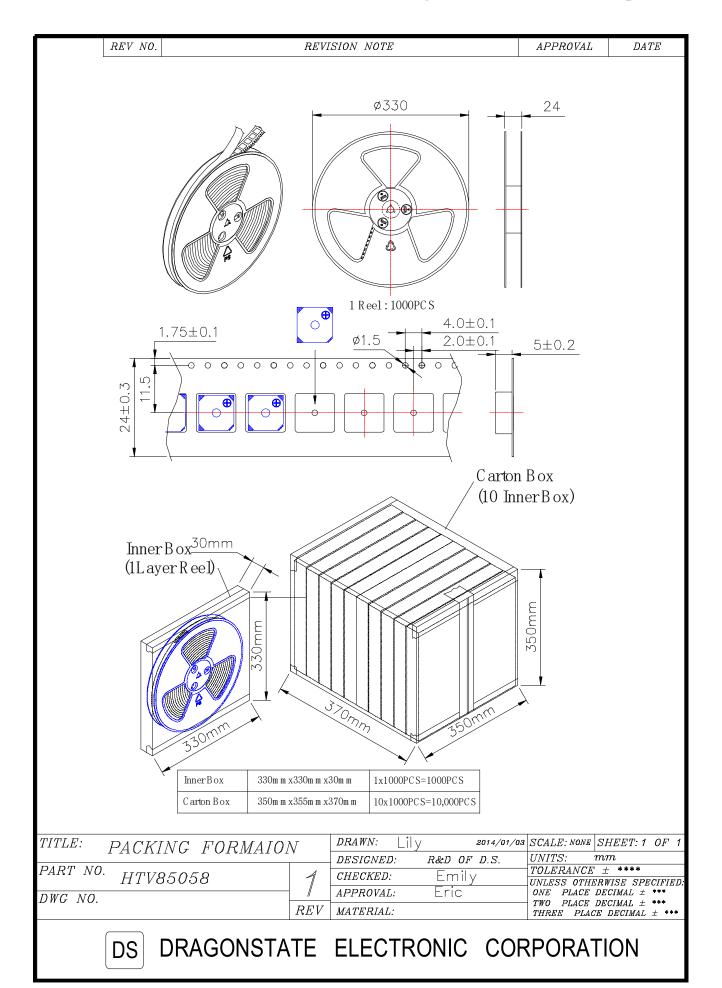


Heat resistant line

(Used when heat resistant reliability test is performed)

(2)Manual soldering

Manual soldering temperature 350 °C within 5 sec.





## 6. History change record

Change Items	Date	Note	Drawn by	Checked by
	2019-05-27	First Issue	Lily	王台平 2019-05-27
印字⊕更新为+	2019-06-05	Second Issue	Lily	王台平 <b>2019-06-05</b>